





DUAL N-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

Features

- Dual N-Channel MOSFET
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Ultra-Small Surface Mount Package
- Lead Free By Design/RoHS Compliant (Note 2)
- ESD Protected Gate up to 2kV
- "Green" Device (Note 4)
- Qualified to AEC-Q101 Standards for High Reliability

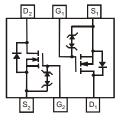
Mechanical Data

- Case: SOT-563
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper lead frame.
 Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 4
- Ordering Information: See Page 4
- Weight: 0.006 grams (approximate)









TOP VIEW

BOTTOM VIEW

TOP VIEW Internal Schematic

Maximum Ratings @TA = 25°C unless otherwise specified

	Characteristic	Symbol	Value	Units	
Drain-Source Voltage	V_{DSS}	20	V		
Gate-Source Voltage			V _{GSS}	±8	V
Drain Current (Note 1)	I _D	540 390	mA		
Pulsed Drain Current (Note 3)			I _{DM}	1.5	Α

SOT-563

Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 1)	P_D	250	mW
Thermal Resistance, Junction to Ambient	$R_{ heta JA}$	500	°C/W
Operating and Storage Temperature Range	$T_{J_i} T_{STG}$	-65 to +150	°C

Notes:

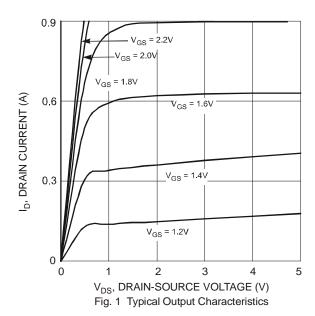
- 1. Device mounted on FR-4 PCB.
- 2. No purposefully added lead.
- 3. Pulse width $\leq 10 \mu S$, Duty Cycle $\leq 1\%$.
- 4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.



Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 5)							
Drain-Source Breakdown Voltage	BV _{DSS}	20			V	$V_{GS} = 0V, I_D = 10\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	1	1	1	μΑ	$V_{DS} = 16V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}			±1	μΑ	$V_{GS} = \pm 4.5 V, V_{DS} = 0 V$	
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V _{GS(th)}	0.5		1.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
			0.4	0.55		$V_{GS} = 4.5V, I_D = 540mA$	
Static Drain-Source On-Resistance	R _{DS (ON)}	_	0.5	0.70	Ω	$V_{GS} = 2.5V, I_D = 500mA$	
	- (- ,		0.7	0.9		$V_{GS} = 1.8V, I_D = 350mA$	
Forward Transfer Admittance	Y _{fs}	200	_	_	ms	$V_{DS} = 10V, I_D = 0.2A$	
Diode Forward Voltage (Note 5)	V _{SD}	0.5	_	1.4	V	$V_{GS} = 0V, I_{S} = 115mA$	
DYNAMIC CHARACTERISTICS					_		
Input Capacitance	C _{iss}		_	150	pF	.,	
Output Capacitance	Coss		_	25	pF	$V_{DS} = 16V, V_{GS} = 0V$ - f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	_	20	pF	1 = 1.0WHZ	
SWITCHING CHARACTERISTICS							
Turn-On Delay Time	t _{d(on)}	_	8.0		ns	V 40V D 470	
Rise Time	t _r		13.3		ns	$V_{DD} = 10V, R_L = 47\Omega,$	
Turn-Off Delay Time	t _{d(off)}	_	53.5	_	ns	$I_D = 200 \text{mA}. V_{GEN} = 4.5 \text{V},$	
Fall Time	t _f		36.1		ns	$R_G = 10\Omega$	

Notes: 5. Short duration pulse test used to minimize self-heating effect.



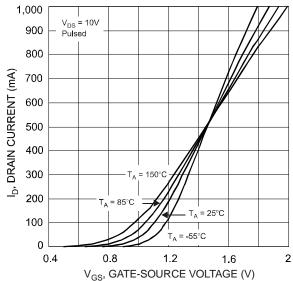
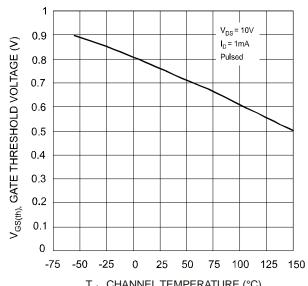


Fig. 2 Reverse Drain Current vs. Source-Drain Voltage





T_{ch}, CHANNEL TEMPERATURE (°C) Fig. 3 Gate Threshold Voltage vs. Channel Temperature

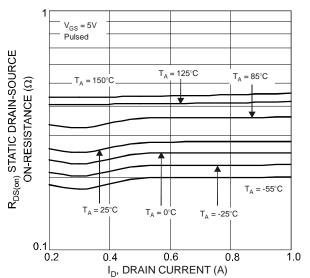


Fig. 5 Static Drain-Source On-Resistance vs. Drain Current

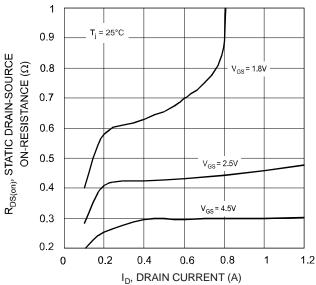


Fig. 7 On-Resistance vs. Drain Current and Gate Voltage

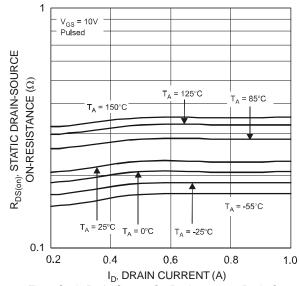
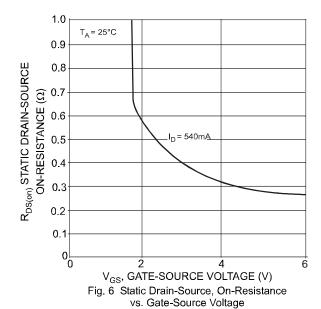


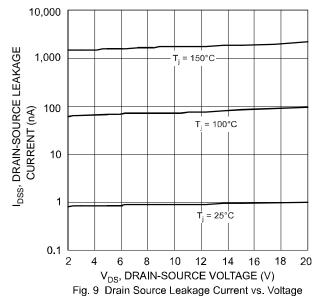
Fig. 4 Static Drain-Source On-Resistance vs. Drain Current

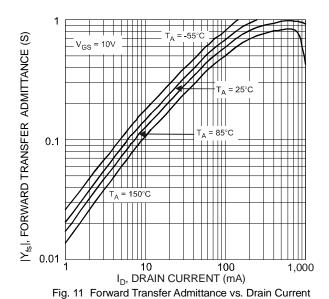


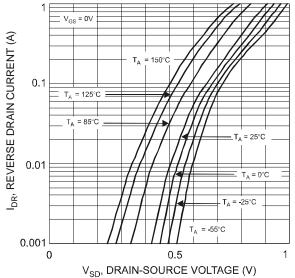
0.5 R_{DS(on)} STATIC DRAIN-SOURCE 0.4 ON-STATE RESISTANCE (Ω) $V_{GS} = 4.5V$, = 540mA $V_{GS} = 10V$ I_D = 280mA 0.1 0 -50 -25 0 25 50 75 100 125 150 T_i, JUNCTION TEMPERATURE (°C)

Fig. 8 Static Drain-Source, On-Resistance vs. Temperature

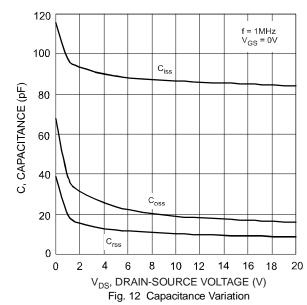








V_{SD}, DRAIN-SOURCE VOLTAGE (V Fig. 10 Reverse Drain Current vs. Source-Drain Voltage

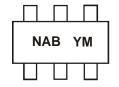


Ordering Information (Note 6)

Part Number	Case	Packaging		
DMN2004VK-7	SOT-563	3000/Tape & Reel		

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



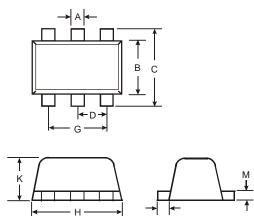
NAB = Marking Code YM = Date Code Marking Y = Year (ex: T = 2006) M = Month (ex: 9 = September)

Date Code Key

Year	200	6	2007		2008	20	09	2010		2011	2	2012
Code	Т		U		V	V	V	Х		Υ		Z
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

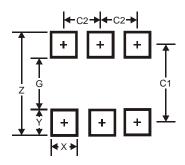


Package Outline Dimensions



	SOT-563					
Dim	Min	Max	Тур			
Α	0.15	0.30	0.20			
В	1.10	1.25	1.20			
С	1.55	1.70	1.60			
D	-	-	0.50			
G	0.90	1.10	1.00			
Н	1.50	1.70	1.60			
K	0.55	0.60	0.60			
L	0.10	0.30	0.20			
M	0.10	0.18	0.11			
All	All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.2
G	1.2
Х	0.375
Y	0.5
C1	1.7
C2	0.5



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